

Application No.: 09/760,741
Amendment dated February 25, 2004
Reply to Office Action dated December 30, 2003

Docket No.: M4065.0374/P374

AMENDMENTS TO THE DRAWINGS

The attached sheet of drawings includes changes to Figure 7.

Figure 7 has been amended to include cavity 25 between the first semiconductor die 20 and the supporting structure 10.

Attachment: Replacement sheet
 Annotated sheet showing changes

REPLACEMENT SHEET



300

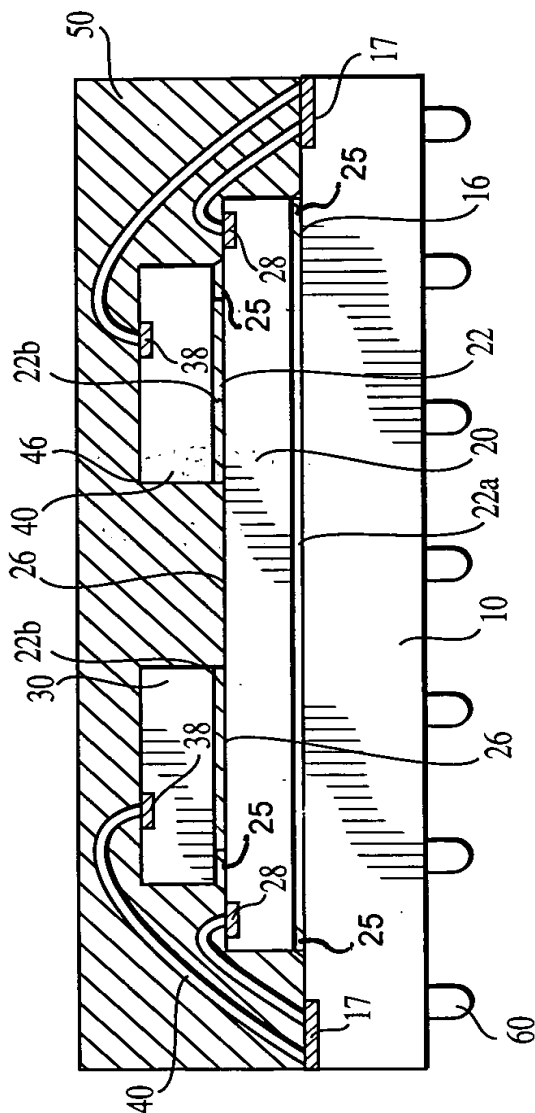


FIG. 7

ANNOTATED SHEET SHOWING CHANGES



300

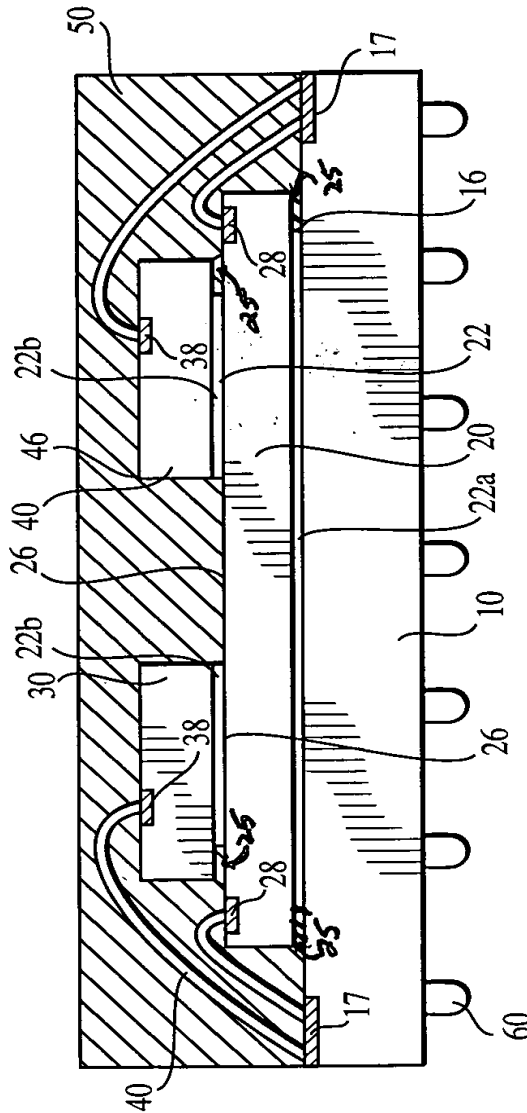


FIG. 7